SLLS085B - JANUARY 1977 - REVISED MAY 1995

- Meets or Exceeds the Requirements of ANSI EIA/TIA-422-B and ITU Recommendation V.11
- Single 5-V Supply
- Balanced-Line Operation
- TTL Compatible
- High Output Impedance in Power-Off Condition
- High-Current Active-Pullup Outputs
- Short-Circuit Protection
- Dual Channels
- Input Clamp Diodes

## 

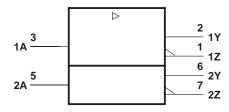
†The PS package is only available left-end taped and reeled, i.e., order SN75158PSLE.

## description

The SN75158 is a dual differential line driver designed to satisfy the requirements set by the ANSI EIA/TIA-422-B and ITU V.11 interface specifications. The outputs provide complementary signals with high-current capability for driving balanced lines, such as twisted pair, at normal line impedance without high power dissipation. The output stages are TTL totem-pole outputs providing a high-impedance state in the power-off condition.

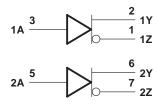
The SN75158 is characterized for operation from 0°C to 70°C.

# logic symbol‡



<sup>‡</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)

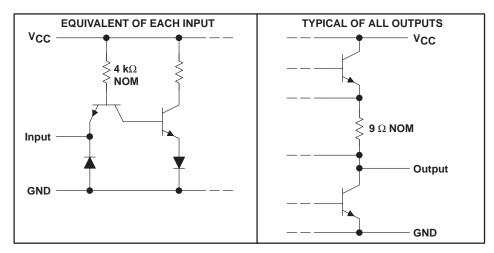




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# schematics of inputs and outputs



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub> (see Note 1)	7 V
Input voltage, V <sub>I</sub>	5.5 V
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T <sub>A</sub>	0°C to 70°C
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values, except differential output voltage VOD, are with respect to network ground terminal. VOD is at the Youtput with respect to the Z output.

#### **DISSIPATION RATING TABLE**

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW
Р	1000 mW	8.0 mW/°C	640 mW
PS	450 mW	3.6 mW/°C	288 mW

## recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	4.75	5	5.25	V
High-level input voltage, VIH	2			V
Low-level input voltage, V <sub>IL</sub>			0.8	V
High-level output current, IOH			-40	mA
Low-level output current, I <sub>OL</sub>			40	mA
Operating free-air temperature, T <sub>A</sub>	0		70	°C



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# electrical characteristics over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST C	CONDITIONS†	MIN	TYP‡	MAX	UNIT	
VIK	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>I</sub> = -12 mA		-0.9	-1.5	V	
Vон	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,	$V_{IL} = 0.8 \text{ V},$ $I_{OH} = -40 \text{ mA}$	2.4	3		٧	
VOL	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,	$V_{IL} = 0.8 \text{ V},$ $I_{OL} = 40 \text{ mA}$		0.2	0.4	٧	
I V <sub>OD1</sub> I	Differential output voltage	$V_{CC} = MAX$ ,	IO = 0		3.5	2×V <sub>OD2</sub>	V	
IV <sub>OD2</sub> I	Differential output voltage	VCC = MIN		2	3		V	
$\Delta V_{OD}$	Change in magnitude of differential output voltage§	V <sub>CC</sub> = MIN	]		±0.02	±0.4	V	
V		$V_{CC} = MAX$			1.8	3	V	
Voc	Common-mode output voltage¶	V <sub>CC</sub> = MIN			1.5	3	٧	
ΔVOC	Change in magnitude of common-mode output voltage§	V <sub>CC</sub> = MIN or MAX			±0.02	±0.4	V	
			V <sub>O</sub> = 6 V		0.1	100		
IO	Output current with power off	$V_{CC} = 0$	V <sub>O</sub> = - 0.25 V		-0.1	-100	μΑ	
			$V_0 = -0.25 \text{ to } 6 \text{ V}$			±100		
II	Input current at maximum input voltage	$V_{CC} = MAX$ ,	V <sub>I</sub> = 5.5 V			1	mA	
lн	High-level input current	$V_{CC} = MAX$ ,	V <sub>I</sub> = 2.4 V			40	μА	
I <sub>I</sub> L	Low-level input current	$V_{CC} = MAX$ ,	V <sub>I</sub> = 0.4 V		-1	-1.6	mA	
los	Short-circuit output current#	V <sub>CC</sub> = MAX		-40	-90	-150	mA	
ICC	Supply current (both drivers)	$V_{CC} = MAX,$ $T_A = 25^{\circ}C,$	Inputs grounded, No load		37	50	mA	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<sup>t</sup> PLH	Propagation delay time, low-to-high-level output	See Figure 2, Termination A		16	25	ns
<sup>t</sup> PHL	Propagation delay time, high-to-low-level output	See Figure 2, Terrilliation A		10	20	ns
<sup>t</sup> PLH	Propagation delay time, low-to-high-level output	See Figure 2, Termination B		13	20	ns
tPHL	Propagation delay time, high-to-low-level output	See Figure 2, Termination B		9	15	ns
tTLH	Transition time, low-to-high-level output	Can Figure 0. Tampination A		4	20	ns
tTLH	Transition time, high-to-low-level output	See Figure 2, Termination A		4	20	ns
	Overshoot factor	See Figure 2, Termination C			10%	

<sup>‡</sup> All typical values are at  $V_{CC}$  = 5 V and  $T_A$  = 25°C except for  $V_{OC}$ , for which  $V_{CC}$  is as stated under test conditions. §  $\Delta V_{OD}$  and  $\Delta |V_{OC}|$  are the changes in magnitudes of  $V_{OD}$  and  $V_{OC}$ , respectively, that occur when the input is changed from a high level to a low

<sup>¶</sup> In ANSI Standard EIA/TIA-422-B, VOC, which is the average of the two output voltages with respect to ground, is called output offset voltage, Vos.

<sup>#</sup>Only one output should be shorted at a time, and duration of the short circuit should not exceed one second.

## PARAMETER MEASUREMENT INFORMATION

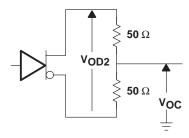
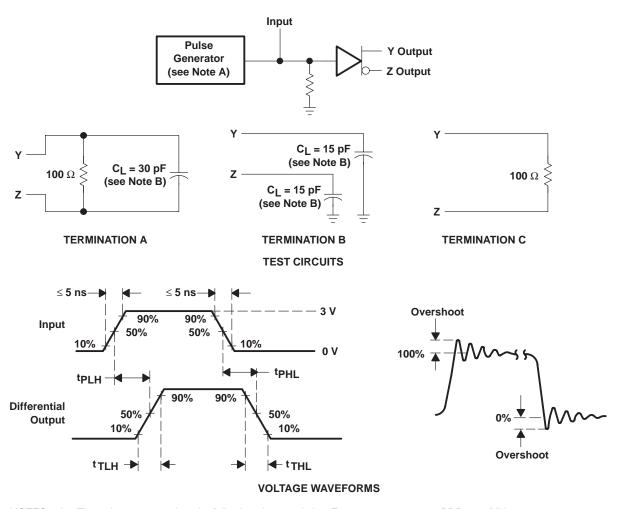


Figure 1. Differential and Common-Mode Output Voltages



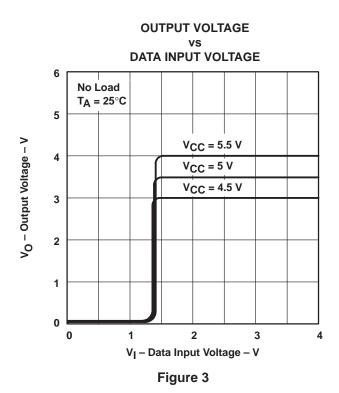
NOTES: A. The pulse generator has the following characteristics:  $Z_O$  = 50  $\Omega$ ,  $t_W$  = 25 ns, PRR  $\leq$  10 MHz.

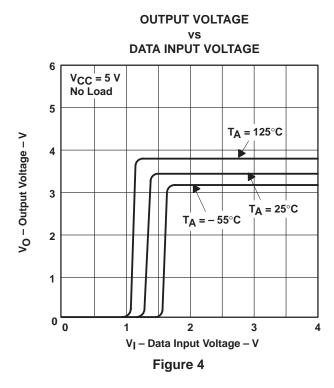
B. C<sub>L</sub> includes probe and jig capacitance.

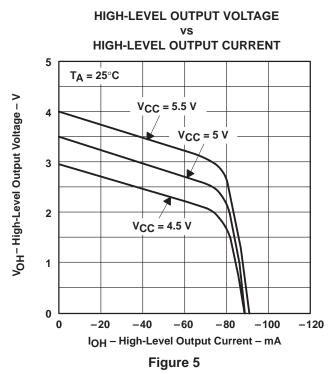
Figure 2. Test Circuit and Voltage Waveforms

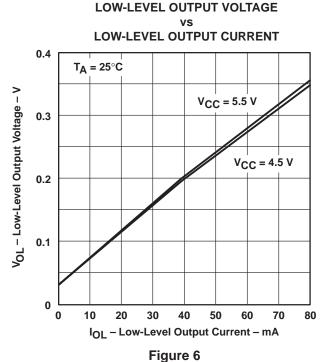


## **TYPICAL CHARACTERISTICS**

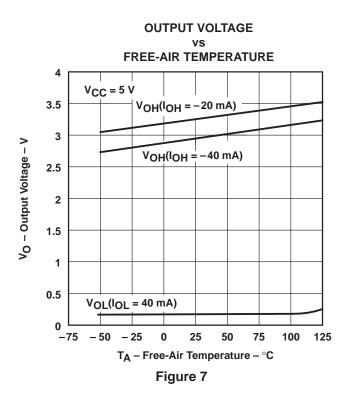


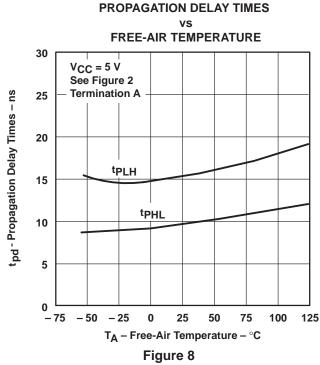


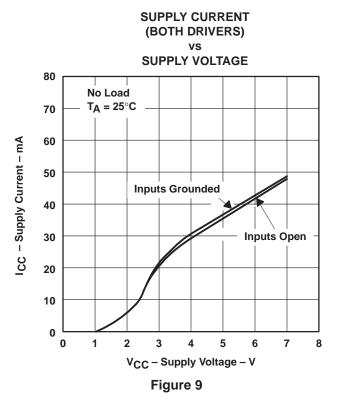


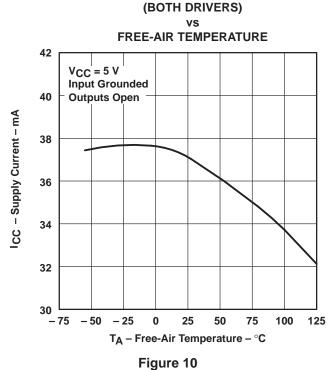


## TYPICAL CHARACTERISTICS









**SUPPLY CURRENT** 

# **TYPICAL CHARACTERISTICS**

# SUPPLY CURRENT (BOTH DRIVERS)

## vs FREQUENCY

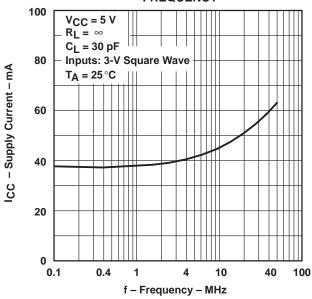


Figure 11

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